

**HIMACHAL PRADESH INFRASTRUCTURE DEVELOPMENT BOARD
(GOVT. OF HIMACHAL PRADESH)**

***EOI (Expression of Interest) for the Empanelment of Merchant Bankers-cum-Arrangers
-cum- Advisors to facilitate the issuance of bonds/raising loan by Designate PSUs/ Organizations of HP
Government.***

Corrigendum/Addendum/Clarification to Pre-Bid queries dated 15.09.2025

In continuation to replies to pre-bid queries and corrigendum/Addendum issued on 12.09.2025, the following corrigendum/Addendum/Clarifications are hereby issued for all prospective bidders.

1. The term **“Lead Manager”** wherever it appears in the EOI document may be read as **“Arranger.”**
2. Amendment to Clause 4 (Eligibility Criteria): Under Clause 4, the sub clause **Fund-Raising Track Record** is amended to include the following addition:

The Bidder must have raised a total of ₹5,000 crores in funds (via loans and/or bond issues) for Central/State Level Undertakings, Financial Institutions, or Body Corporates/Companies in the last five years from the date of bid submission **including two bond issues for any State Government PSUs in India during this period.**
3. EMD of successful bidder shall be retained for the entire period of empanelment and refunded thereafter & in case of unsuccessful bidder the EMD will be returned/ refunded within one month after evaluation process is over. The EMD will not carry any interest.
4. EMD shall be payable only through DD or online transfer into Bank Account of HPIDB. (*account detail is already mentioned at S.No. 11 of EOI document*)
5. The last date for submission of proposal is **22.09.2025 till 4.00 PM**

For further information, please contact

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